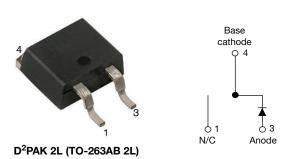


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Hyperfast Rectifier, 30 A FRED Pt® G5



LINKS TO ADDITIONAL RESOURCES





PRIMARY CHARACTERISTICS							
I _{F(AV)} 30 A							
V _R	600 V						
V _F at I _F at 125 °C	1.15 V						
t _{rr} (typ.)	25 ns						
T _J max.	175 °C						
Package	D ² PAK 2L (TO-263AB 2L)						
Circuit configuration	Single						

FEATURES

 Best in class forward voltage drop and switching losses trade off



FREE

- · Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications.

MECHANICAL DATA

Case: D²PAK 2L (TO-263AB 2L)

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per

J-STD-002

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Repetitive peak reverse voltage	V_{RRM}		600	V				
Average rectified forward current	I _{F(AV)}	T _C = 113 °C, D = 0.50	30	Α				
Repetitive peak forward current	I _{FRM}	$T_C = 113 ^{\circ}C, D = 0.50, f = 20 \text{kHz}$	60					
Non-repetitive peak surge current	I _{FSM}	$T_C = 25$ °C, $t_p = 10$ ms, sine wave	330					
Operating junction and storage temperature	T _J , T _{Stg}		-55 to +175	°C				

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL TEST CONDITIONS			TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	600	-	-	.,		
Famous valless	V _F	I _F = 30 A	-	1.3	1.6	V		
Forward voltage		I _F = 30 A, T _J = 125 °C	-	1.15	-			
Payaraa laakaga aurrant	I _R	$V_R = V_R$ rated	-	-	20			
Reverse leakage current		$T_J = 125$ °C, $V_R = V_R$ rated		-	500	μA		
Junction capacitance	C _T	V _R = 200 V	-	36	-	pF		
Series inductance	L _S	Measured to lead 5 mm from package body	-	8	-	nH		



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS		
		I _F = 1.0 A,dI _F /dt = 100 A/μs, V _R = 30 V		-	25	-		
Reverse recovery time	t _{rr}	T _J = 25 °C		-	41	-	ns	
		T _J = 125 °C		-	58	-		
Dook recovery current		T _J = 25 °C	$I_F = 20 \text{ A}$	-	19	-	А	
Peak recovery current	I _{RRM}	T _J = 125 °C	dI _F /dt = 1000 A/μs - V _R = 400 V	-	32	-		
Devices received above	0	T _J = 25 °C		-	419	-	nC	
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	1176	-		
Poverse receivery time		T _J = 25 °C	I _F = 30 A dI _F /dt = 1000 A/μs V _R = 400 V	-	46	-	ns A	
Reverse recovery time	t _{rr}	T _J = 125 °C		-	65	-		
Dools recovery comment		T _J = 25 °C		-	21	-		
Peak recovery current	I _{RRM}	T _J = 125 °C		-	36	-		
Reverse recovery charge	0	T _J = 25 °C		-	550	-	nC	
	Q _{rr}	T _J = 125 °C		-	1560	-		

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Thermal resistance, junction-to-case	R _{thJC}		-	-	1.3	°C/W		
Weight			-	2.0	-	g		
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C		
Marking device		Case style D ² PAK 2L (TO-263AB 2L)	E5TH3006S					

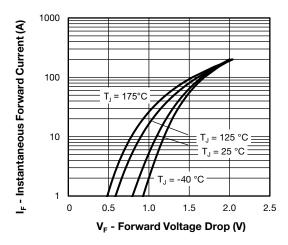


Fig. 1 - Typical Forward Voltage Drop Characteristics, Per Leg

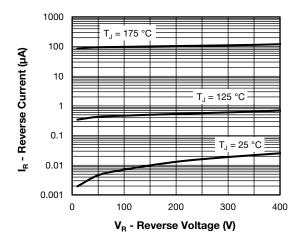


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage, Per Leg

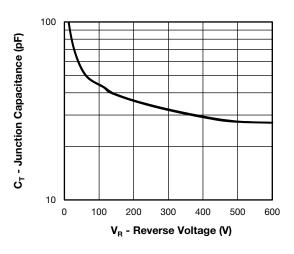


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, Per Leg

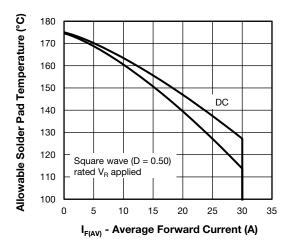


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current, Per Leg

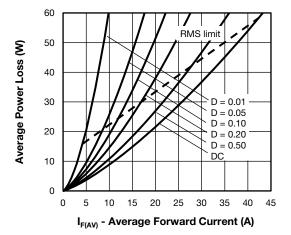


Fig. 5 - Forward Power Loss Characteristics, Per Leg



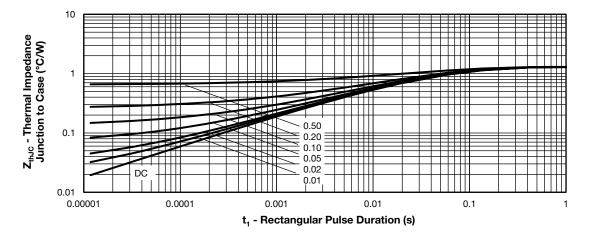


Fig. 6 - Transient Thermal Impedance, Junction to Case, Per Leg

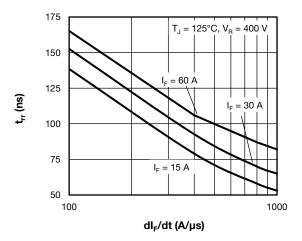


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt, Per Leg

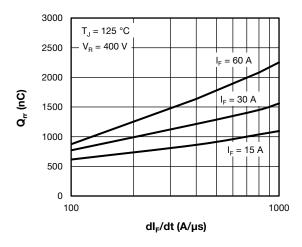


Fig. 8 - Typical Reverse Recovery Charge vs. dI_F/dt, Per Leg

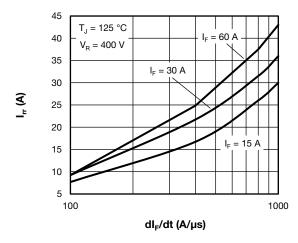


Fig. 9 - Typical Reverse Recovery Current vs. dl_F/dt, Per Leg

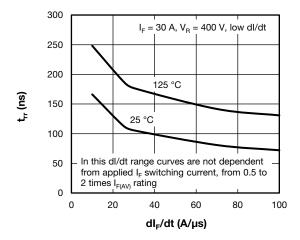
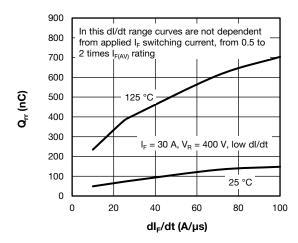


Fig. 10 - Typical Reverse Recovery Time vs. dI_F/dt, Per Leg



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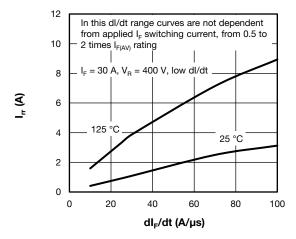


Fig. 11 - Typical Reverse Recovery Charge vs. dl_F/dt, Per Leg

Fig. 12 - Typical Reverse Recovery Current vs. dl_F/dt, Per Leg

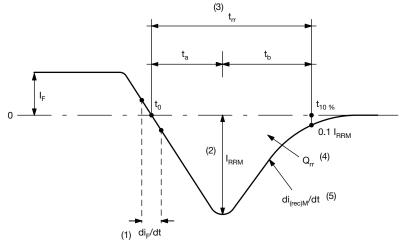


Fig. 13 - Reverse Recovery Waveform and Definitions

Notes

- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from t₀, crossing point of negative going I_F, to point t_{10%}, 0.1 I_{RRM}
- $^{(4)}$ Q_{rr} area under curve defined by t_0 and t_{10} %

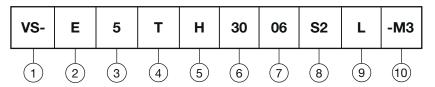
$$Q_{rr} = \int_{t_0}^{t_{10\%}} I(t)dt$$

(5) di_(rec)M/dt - peak rate of change of current during t_b portion of t_{rr}



ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- E = single diode
- **3** 5 = FRED generation 5
- 4 Package:
 - $T = D^2PAK$ (TO-263) package
- 5 H = hyperfast recovery
- **6** Current rating (30 = 30 A)
- 7 Voltage rating (06 = 600 V)
- 8 S2 = true 2 pin D^2PAK
- 9 None = tube (50 pieces)
 - L = tape and reel (left oriented, for D^2PAK package)

If needed different orientation/packaging, please contact factory

10 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

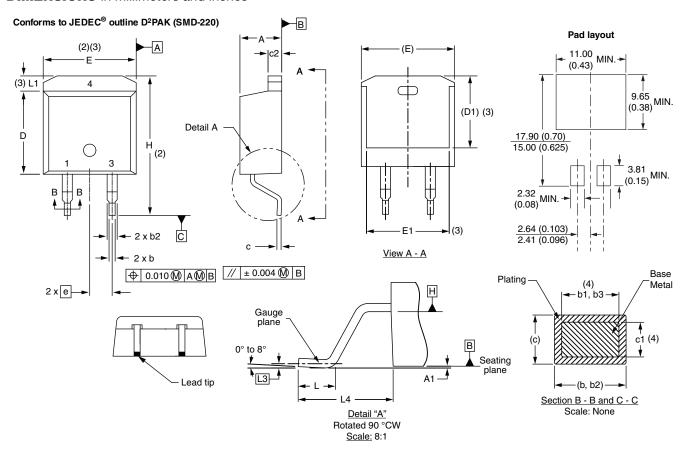
ORDERING INFORMATION (Example)						
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION				
VS-E5TH3006S2L-M3	800	13" diameter reel				

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?96683			
Part marking information	www.vishay.com/doc?96693			
Packaging information	www.vishay.com/doc?95032			
SPICE model	www.vishay.com/doc?96919			



D²PAK 2L (TO-263AB 2L)

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INCHES		NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INCHES		NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



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